



Comtech Telecommunications Corp. to Participate at the Jefferies 2019 Semiconductor, Hardware and Communications Infrastructure Summit

August 22, 2019

MELVILLE, N.Y.--(BUSINESS WIRE)-- August 22, 2019--Comtech Telecommunications Corp. (NASDAQ: CMTL) announced today that it will participate at the Jefferies 2019 Semiconductor, Hardware and Communications Infrastructure Summit at the Ritz-Carlton in Chicago, Illinois, on Wednesday, August 28, 2019.

Michael D. Porcelain, Senior Vice President and Chief Operating Officer, and Michael A. Bondi, Chief Financial Officer will conduct one-on-one meetings with investors throughout the day.

Comtech Telecommunications Corp. designs, develops, produces and markets innovative products, systems and services for advanced communications solutions. The Company sells products to a diverse customer base in the global commercial and government communications markets.

Certain information in this press release contains statements that are forward-looking in nature and involve certain significant risks and uncertainties. Actual results could differ materially from such forward-looking information. The Company's Securities and Exchange Commission filings identify many such risks and uncertainties. Any forward-looking information in this press release is qualified in its entirety by the risks and uncertainties described in such Securities and Exchange Commission filings.

PCMTL

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